

# Hyperfast Rectifier, 8 A FRED Pt® G5



#### **LINKS TO ADDITIONAL RESOURCES**





PRIMARY CHARACTERISTICS									
I <sub>F(AV)</sub>	8 A								
$V_R$	1200 V								
V <sub>F</sub> at I <sub>F</sub> at 125 °C	2.1 V								
t <sub>rr</sub>	27 ns								
T <sub>J</sub> max.	175 °C								
Package	TO-220AC 2L								
Circuit configuration	Single								

#### **FEATURES**

Hyperfast and optimized Q<sub>rr</sub>



 Best in class forward voltage drop and switching RoHS losses trade off

HALOGEN **FREE** 

Optimized for high speed operation

• 175 °C maximum operating junction temperature

- Polyimide passivation
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

### **DESCRIPTION / APPLICATIONS**

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for high frequency converters, both soft switched / resonant. Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

#### **MECHANICAL DATA**

Case: TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

Polarity: as per marking device details

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Repetitive peak reverse voltage	$V_{RRM}$		1200	V						
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 121 °C, D = 0.50	8							
Repetitive peak forward current	I <sub>FRM</sub>	T <sub>C</sub> = 121 °C, D = 0.50, f = 20 kHz	16	Α						
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_C = 45$ °C, $t_p = 10$ ms, sine wave	60							
Operating junction and storage temperature	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	$V_{BR}$ , $V_{R}$	I <sub>R</sub> = 100 μA	1200	-	-	.,				
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 8 A	-	2.5	3.4	V				
Forward voltage		I <sub>F</sub> = 8 A, T <sub>J</sub> = 125 °C	-	2.1	-					
Deverage legisers overset	I <sub>R</sub>	$V_R = V_R$ rated	-	-	50					
Reverse leakage current		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA				
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V	-	5	-	pF				
Series inductance	L <sub>S</sub>	Measured to lead 5 mm from package body	-	8	-	nH				



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)											
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNITS					
		I <sub>F</sub> = 1.0 A, dI <sub>F</sub>	=/dt = 100 A/μs, V <sub>R</sub> = 30 V	=	27	38					
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	87	-	ns				
		T <sub>J</sub> = 125 °C		-	150	-					
Peak recovery current	1	T <sub>J</sub> = 25 °C	$I_F = 6 \text{ A},$	=	7	-	Α				
Feak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C	$dI_F/dt = 400 A/\mu s$ , $V_B = 400 V$	-	9	-					
Devices as a second of the second	0	T <sub>J</sub> = 25 °C		-	200	-	nC				
Reverse recovery charge	$Q_{rr}$	T <sub>J</sub> = 125 °C		-	520	-					
Reverse recovery time	+	T <sub>J</sub> = 25 °C		-	55	-	ns				
neverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		=	95	-	115				
Dook receivent ourrent	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 8 A, dI <sub>F</sub> /dt = 1000 A/μs,	-	14	-	Α				
Peak recovery current		T <sub>J</sub> = 125 °C	$V_{R} = 800 \text{ V}$	-	19	-	A				
Poverse recovery charge	0	T <sub>J</sub> = 25 °C		=	350	-	nC				
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	960	-					

THERMAL - MECHANICAL SPECIFICATIONS											
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS					
Thermal resistance, junction-to-case	R <sub>thJC</sub>		-	-	2.3	°C/W					
Weight			-	2.0	=.	g					
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)					
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C					
Marking device		Case style TO-220AC 2L	E5TX0812								



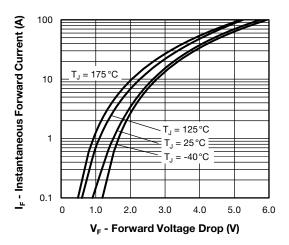


Fig. 1 - Forward Voltage Drop Characteristics

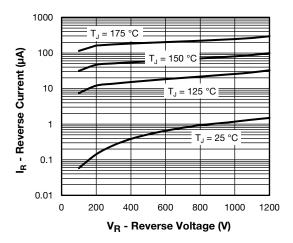


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

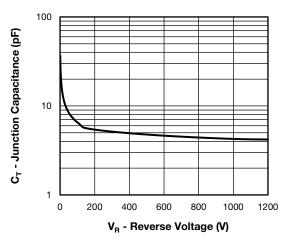


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

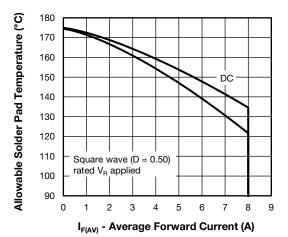


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current

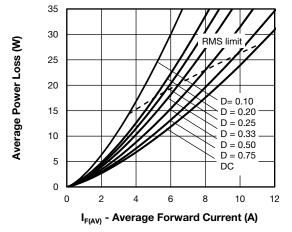


Fig. 5 - Forward Power Loss Characteristics

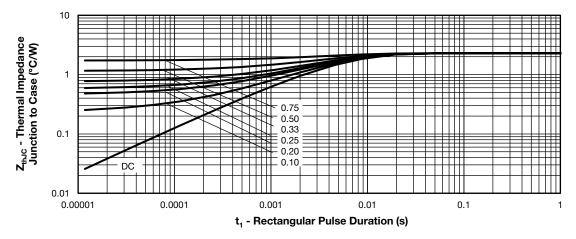


Fig. 6 - Transient Thermal Impedance, Junction to Case

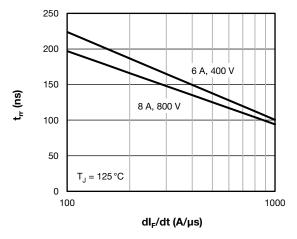


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

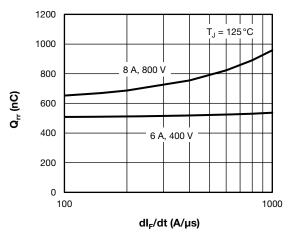


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

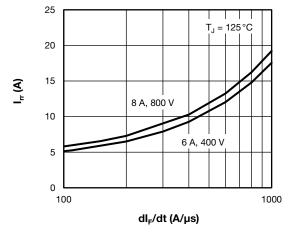


Fig. 9 - Typical Recovery Current vs. dI<sub>F</sub>/dt

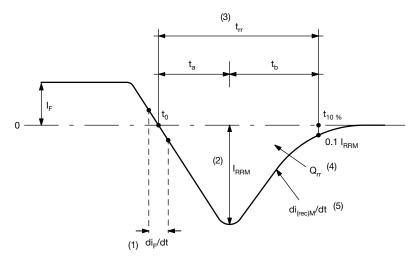


Fig. 10 - Reverse Recovery Waveform and Definitions

#### **Notes**

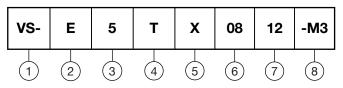
- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from t<sub>0</sub>, crossing point of negative going I<sub>F</sub>, to point t<sub>10%</sub>, 0.1 I<sub>RRM</sub>
- $^{(4)}$   $\,$  Q  $_{rr}$  area under curve defined by  $t_0$  and  $t_{10}$  %

$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

 $^{(5)}$  di<sub>(rec)</sub>M/dt - peak rate of change of current during  $t_b$  portion of  $t_{rr}$ 

### **ORDERING INFORMATION TABLE**

Device code



- 1 Vishay Semiconductors product
- **2** E = single diode
- **3** 5 = FRED generation 5
- 4 Package:
  - T = TO-220AC 2L
- 5 X = hyperfast recovery
- 6 Current rating (08 = 8 A)
- 7 Voltage rating (12 = 1200 V)
- 8 Environmental digit:
  - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

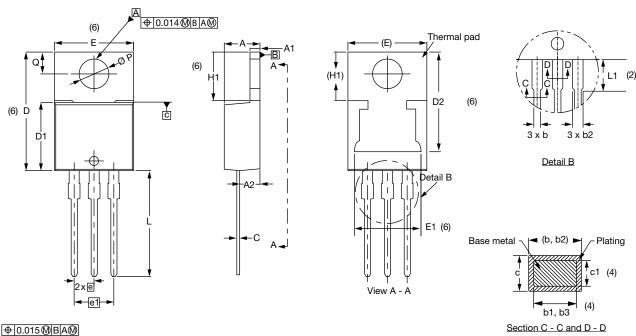
ORDERING INFORMATION (Example)									
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION							
VS-E5TX0812-M3	50	Antistatic plastic tubes							

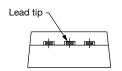
LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?96156
Part marking information	www.vishay.com/doc?95391



### **TO-220AB 3L**

#### **DIMENSIONS** in millimeters and inches





Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIM	IETERS	INC	HES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183		D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055		Е	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115		E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040		е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4	e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068		H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4	L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024		L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4	ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3	Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355							

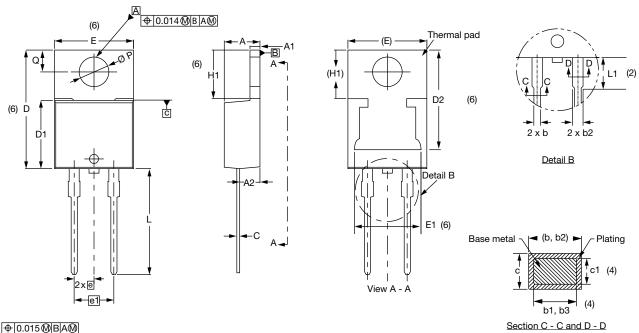
#### **Notes**

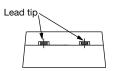
- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



### **TO-220AC 2L**

#### **DIMENSIONS** in millimeters and inches





Conforms to JEDEC® outline TO-220AC

SYMBOL	MILLIM	IETERS	INC	HES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
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A1	1.14	1.40	0.045	0.055		Е	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115		E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040		е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4	e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068		H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4	L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024		L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4	ØΡ	3.54	3.91	0.139	0.154	
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